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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	10200
Total RAM Bits	282624
Number of I/O	147
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfecp10e-3qn208i

Architecture Overview

The LatticeECP-DSP and LatticeEC architectures contain an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM Embedded Block RAM (EBR), as shown in Figures 2-1 and 2-2. In addition, LatticeECP-DSP supports an additional row of DSP blocks, as shown in Figure 2-2.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional unit without RAM/ROM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM, ROM and register functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row. The PFU blocks are used on the outside rows. The rest of the core consists of rows of PFF blocks interspersed with rows of PFU blocks. For every three rows of PFF blocks there is a row of PFU blocks.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. sysMEM EBRs are large dedicated fast memory blocks. They can be configured as RAM or ROM.

The PFU, PFF, PIC and EBR Blocks are arranged in a two-dimensional grid with rows and columns as shown in Figure 2-1. The blocks are connected with many vertical and horizontal routing channel resources. The place and route software tool automatically allocates these routing resources.

At the end of the rows containing the sysMEM Blocks are the sysCLOCK Phase Locked Loop (PLL) Blocks. These PLLs have multiply, divide and phase shifting capability; they are used to manage the phase relationship of the clocks. The LatticeECP/EC architecture provides up to four PLLs per device.

Every device in the family has a JTAG Port with internal Logic Analyzer (ispTRACY) capability. The sysCONFIG™ port which allows for serial or parallel device configuration. The LatticeECP/EC devices use 1.2V as their core voltage.

Routing

There are many resources provided in the LatticeECP/EC devices to route signals individually or as busses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, the routing of both short and long connections between PFUs.

The ispLEVER design tool suite takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

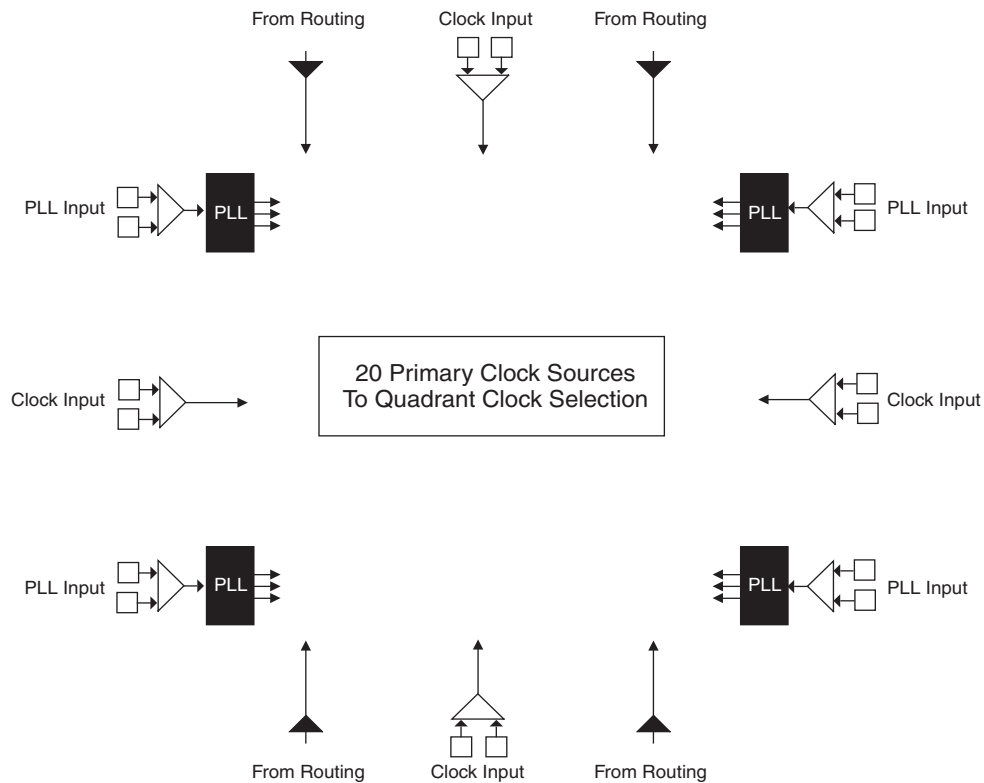
Clock Distribution Network

The clock inputs are selected from external I/O, the sysCLOCK™ PLLs or routing. These clock inputs are fed through the chip via a clock distribution system.

Primary Clock Sources

LatticeECP/EC devices derive clocks from three primary sources: PLL outputs, dedicated clock inputs and routing. LatticeECP/EC devices have two to four sysCLOCK PLLs, located on the left and right sides of the device. There are four dedicated clock inputs, one on each side of the device. Figure 2-6 shows the 20 primary clock sources.

Figure 2-6. Primary Clock Sources



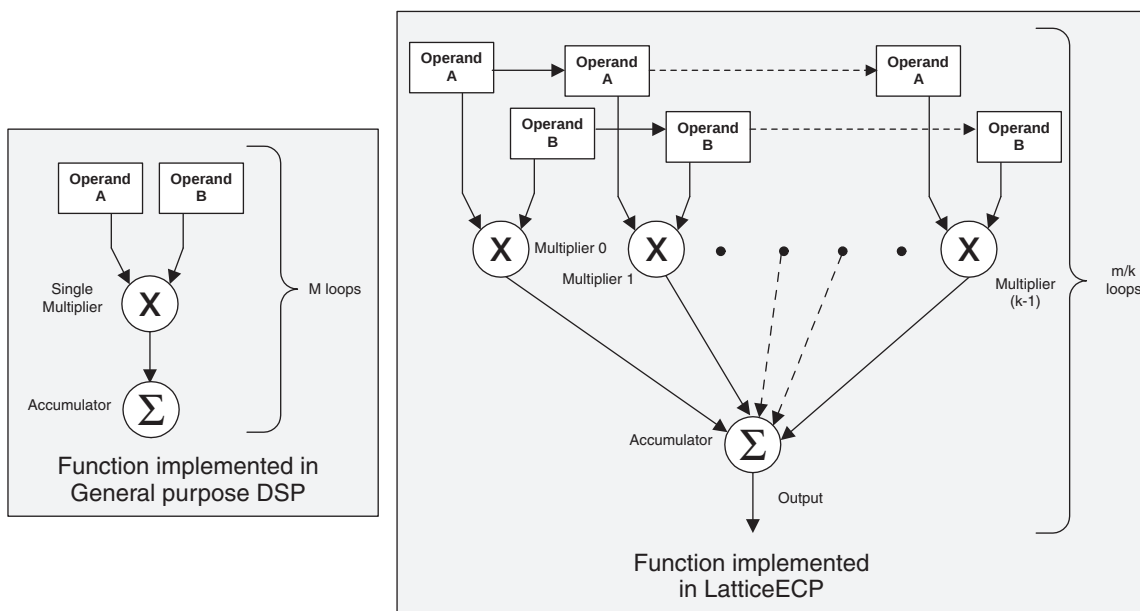
Note: Smaller devices have two PLLs.

decoders. These complex signal processing functions use similar building blocks such as multiply-adders and multiply-accumulators.

sysDSP Block Approach Compared to General DSP

Conventional general-purpose DSP chips typically contain one to four (Multiply and Accumulate) MAC units with fixed data-width multipliers; this leads to limited parallelism and limited throughput. Their throughput is increased by higher clock speeds. The LatticeECP, on the other hand, has many DSP blocks that support different data-widths. This allows the designer to use highly parallel implementations of DSP functions. The designer can optimize the DSP performance vs. area by choosing an appropriate level of parallelism. Figure 2-18 compares the serial and the parallel implementations.

Figure 2-18. Comparison of General DSP and LatticeECP-DSP Approaches



sysDSP Block Capabilities

The sysDSP block in the LatticeECP-DSP family supports four functional elements in three 9, 18 and 36 data path widths. The user selects a function element for a DSP block and then selects the width and type (signed/unsigned) of its operands. The operands in the LatticeECP-DSP family sysDSP Blocks can be either signed or unsigned but not mixed within a function element. Similarly, the operand widths cannot be mixed within a block.

The resources in each sysDSP block can be configured to support the following four elements:

- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADD (Multiply, Addition/Subtraction)
- MULTADDSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available in each block depends on the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-1 shows the capabilities of the block.

Table 2-7. Maximum Number of Elements in a Block

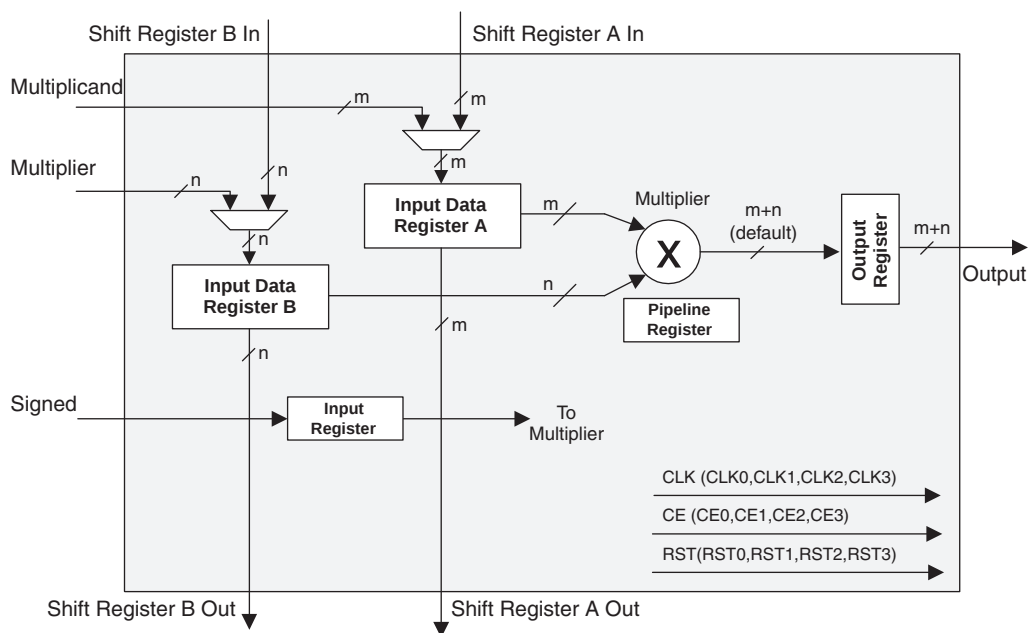
Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADD	4	2	—
MULTADDSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as shift registers from previous operand registers. In addition by selecting “dynamic operation” in the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle. Similarly by selecting ‘Dynamic operation’ in the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-19 shows the MULT sysDSP element.

Figure 2-19. MULT sysDSP Element



MAC sysDSP Element

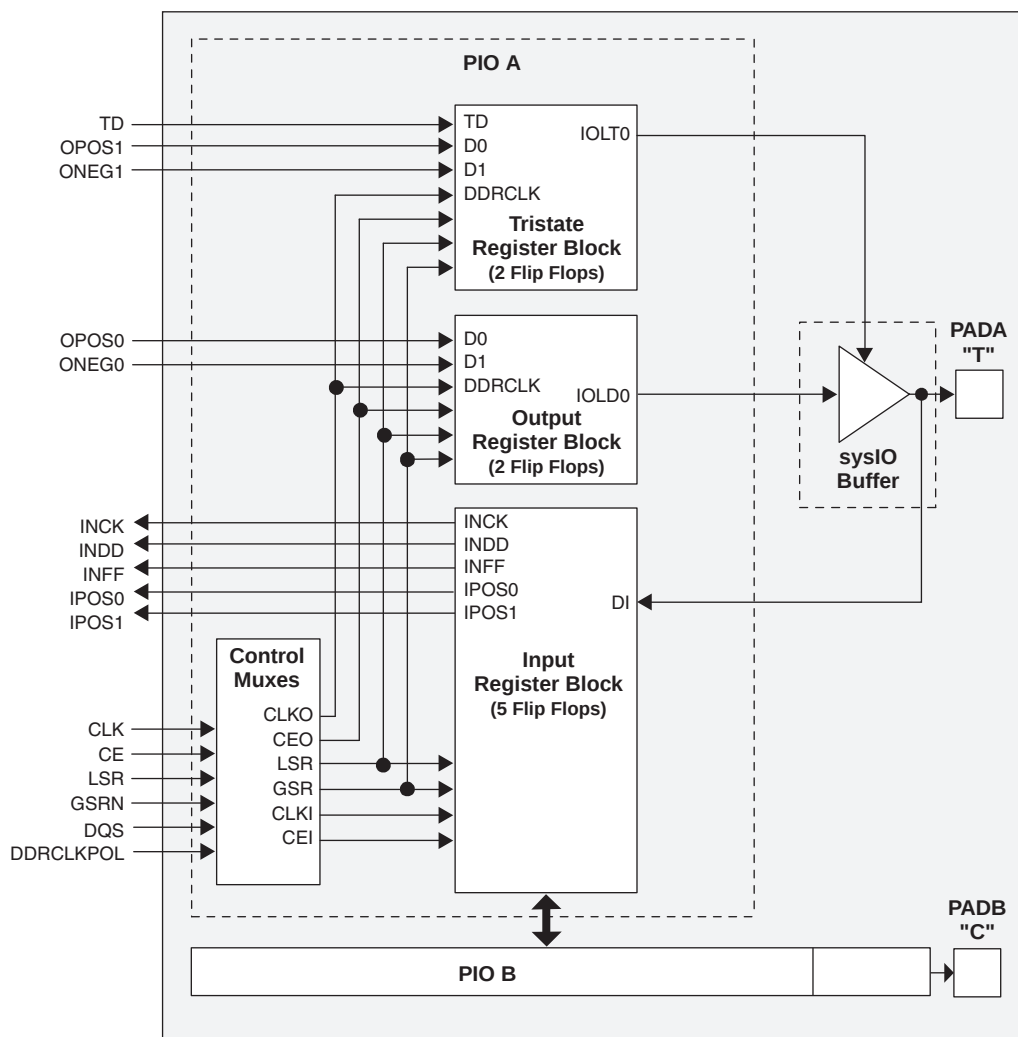
In this case the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers but the output register is always enabled. The output register is used to store the accumulated value. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-20 shows the MAC sysDSP element.

For further information about the sysDSP block, please see the list of technical information at the end of this data sheet.

Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O Buffers which are then connected to the PADs as shown in Figure 2-24. The PIO Block supplies the output data (DO) and the Tri-state control signal (TO) to sysI/O buffer, and receives input from the buffer.

Figure 2-24. PIC Diagram



Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-25. The PAD Labels “T” and “C” distinguish the two PIOs. Only the PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs.

One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus which spans the set of 16 PIOs. Figure 2-25 shows the assignment of DQS pins in each set of 16 PIOs. The exact DQS pins are shown in a dual function in the Logic Signal Connections table at the end of this data sheet. Additional detail is provided in the Signal Descriptions table at the end of this data sheet. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. This interface is designed for memories that support one DQS strobe per eight bits of data.

Absolute Maximum Ratings^{1, 2, 3}

Supply Voltage V_{CC}	-0.5 to 1.32V
Supply Voltage V_{CCAUX}	-0.5 to 3.75V
Supply Voltage V_{CCJ}	-0.5 to 3.75V
Output Supply Voltage V_{CCIO}	-0.5 to 3.75V
Dedicated Input Voltage Applied ⁴	-0.5 to 4.25V
I/O Tristate Voltage Applied ⁴	-0.5 to 3.75V
Storage Temperature (Ambient)	-65 to 150°C
Junction Temp. (Tj)	+125°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice *Thermal Management* document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
V_{CC}	Core Supply Voltage	1.14	1.26	V
V_{CCAUX}^3	Auxiliary Supply Voltage	3.135	3.465	V
V_{CCPLL}	PLL Supply Voltage for ECP/EC33	1.14	1.26	V
$V_{CCIO}^{1, 2}$	I/O Driver Supply Voltage	1.140	3.465	V
V_{CCJ}^1	Supply Voltage for IEEE 1149.1 Test Access Port	1.140	3.465	V
t_{JCOM}	Junction Commercial Operation	0	85	°C
t_{JIND}	Junction Industrial Operation	-40	100	°C

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} .
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 3mV/ μ s for commercial and 0.6 mV/ μ s for industrial device operations during power up when transitioning between 0.8V and 1.8V.

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Top and Bottom General Purpose sysI/Os (Banks 0, 1, 4 and 5), JTAG and Dedicated sysCONFIG Pins						
I_{DK_TB}	Input or I/O Leakage Current	0 δ V_{IN} δ V_{IH} (MAX.)	—	—	+/-1000	μ A
Left and Right General Purpose sysI/Os (Banks 2, 3, 6 and 7)						
I_{DK_LR}	Input or I/O Leakage Current	$V_{IN} \delta V_{CCIO}$	—	—	+/-1000	μ A
		$V_{IN} > V_{CCIO}$	—	35	—	mA

1. Insensitive to sequence of V_{CC} , V_{CCAUX} and V_{CCIO} . However, assumes monotonic rise/fall rates for V_{CC} , V_{CCAUX} and V_{CCIO} .
2. 0 δ $V_{CC} \delta V_{CC}$ (MAX), 0 δ $V_{CCIO} \delta V_{CCIO}$ (MAX) or 0 δ $V_{CCAUX} \delta V_{CCAUX}$ (MAX).
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.

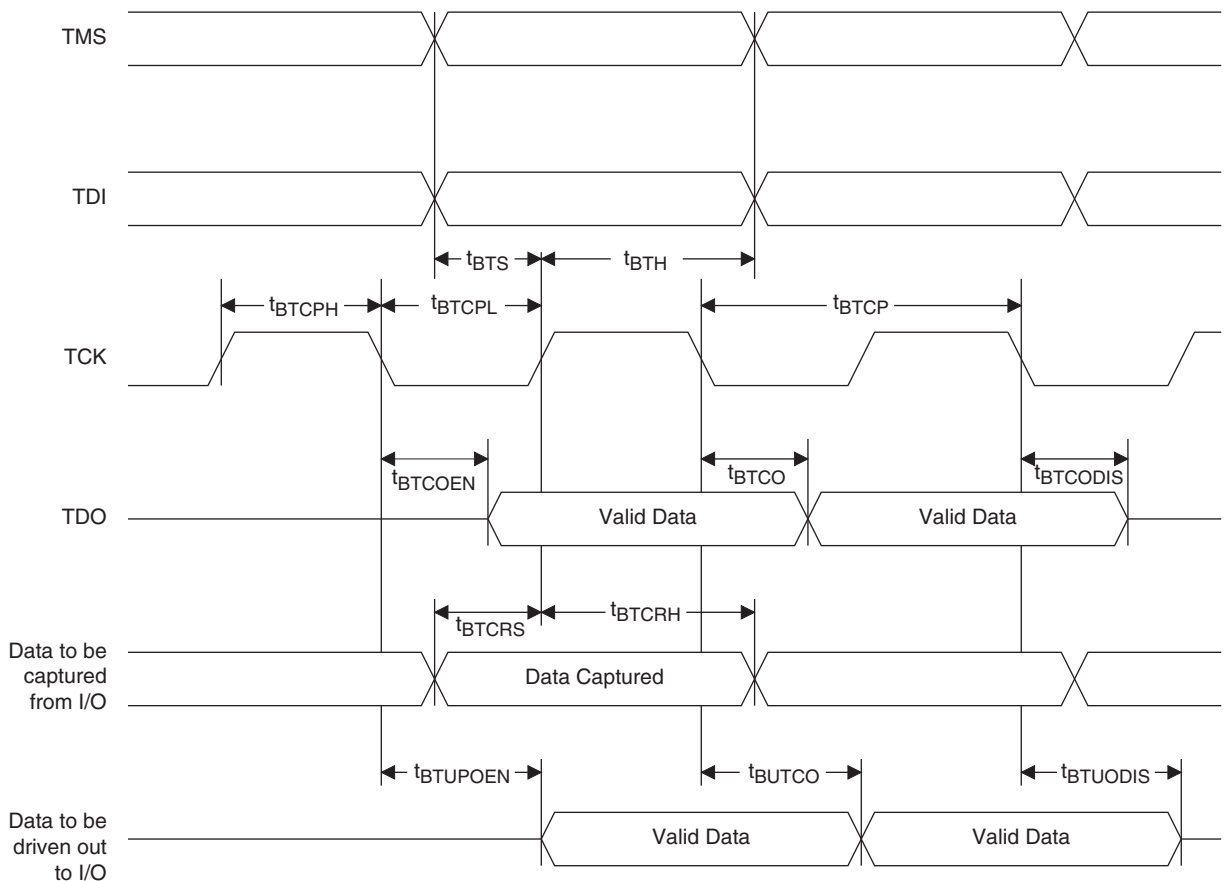
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
t_{BTCODIS}	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
t_{BTUODIS}	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
t_{BTUPOEN}	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.G 0.30

Figure 3-20. JTAG Port Timing Waveforms



LFEC1, LFEC3 Logic Signal Connections: 100 TQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
41	PB11A	4	T	VREF1_4	PB19A	4	T	VREF1_4
42	PB11B	4	C	CSN	PB19B	4	C	CSN
43	PB12B	4		D0/SPID7	PB20B	4		D0/SPID7
44	PB13A	4	T	D2/SPID5	PB21A	4	T	D2/SPID5
45	PB13B	4	C	D1/SPID6	PB21B	4	C	D1/SPID6
46	PB14A	4	T	BDQS14	PB22A	4	T	BDQS22
47	PB14B	4	C	D3/SPID4	PB22B	4	C	D3/SPID4
48	PB15B	4		D4/SPID3	PB23B	4		D4/SPID3
49	PB16B	4		D5/SPID2	PB24B	4		D5/SPID2
50	PB17B	4		D6/SPID1	PB25B	4		D6/SPID1
51*	GND3 GND4	-			GND3 GND4	-		
52	PR10B	3	C	RLM0_PLLC_FB_A	PR14B	3	C	RLM0_PLLC_FB_A
53	PR10A	3	T	RLM0_PLLT_FB_A	PR14A	3	T	RLM0_PLLT_FB_A
54	PR9B	3	C	RLM0_PLLC_IN_A	PR13B	3	C	RLM0_PLLC_IN_A
55	PR9A	3	T	RLM0_PLLT_IN_A	PR13A	3	T	RLM0_PLLT_IN_A
56	VCCIO3	3			VCCIO3	3		
57	PR8B	3	C	DI/CSSPIN	PR12B	3	C	DI/CSSPIN
58	PR8A	3	T	DOUT/CSON	PR12A	3	T	DOUT/CSON
59	PR7B	3	C	BUSY/SISPI	PR11B	3	C	BUSY/SISPI
60	PR7A	3	T	D7/SPID0	PR11A	3	T	D7/SPID0
61	CFG2	3			CFG2	3		
62	CFG1	3			CFG1	3		
63	CFG0	3			CFG0	3		
64	VCC	-			VCC	-		
65	PROGRAMN	3			PROGRAMN	3		
66	CCLK	3			CCLK	3		
67	INITN	3			INITN	3		
68	GND	-			GND	-		
69	DONE	3			DONE	3		
70	PR5B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0
71	PR5A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0
72	PR2B	2		VREF1_2	PR2B	2		VREF1_2
73	VCCIO2	2			VCCIO2	2		
74	GND2	2			GND2	2		
75	PT17B	1	C		PT25B	1	C	
76	PT17A	1	T		PT25A	1	T	
77	PT14B	1	C		PT22B	1	C	
78	PT14A	1	T	TDQS14	PT22A	1	T	TDQS22
79	PT13A	1			PT21A	1		
80	PT12B	1	C		PT20B	1	C	
81	PT12A	1	T		PT20A	1	T	

LFEC6/EC6, LFEC6/EC10 Logic Signal Connections: 208 PQFP

Pin Number	LFEC6/LFEC6				LFEC10/LFEC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1*	GND0 GND7	-			GND0 GND7	-		
2	VCCIO7	7			VCCIO7	7		
3	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
4	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
5	NC	-			VCC	-		
6	NC	-			GND	-		
7	PL3B	7			PL12B	7		
8	PL4A	7	T		PL13A	7	T	
9	PL4B	7	C		PL13B	7	C	
10	PL5A	7	T		PL14A	7	T	
11	PL5B	7	C		PL14B	7	C	
12	PL6A	7	T	LDQS6	PL15A	7	T	LDQS15
13	VCCIO7	7			VCCIO7	7		
14	PL6B	7	C		PL15B	7	C	
15	PL7A	7	T		PL16A	7	T	
16	PL7B	7	C		PL16B	7	C	
17	PL8A	7	T		PL17A	7	T	
18	GND7	7			GND7	7		
19	PL8B	7	C		PL17B	7	C	
20	PL9A	7	T	PCLKT7_0	PL18A	7	T	PCLKT7_0
21	PL9B	7	C	PCLKC7_0	PL18B	7	C	PCLKC7_0
22	VCCAUX	-			VCCAUX	-		
23	XRES	6			XRES	6		
24	VCC	-			VCC	-		
25	GND	-			GND	-		
26	VCC	-			VCC	-		
27	TCK	6			TCK	6		
28	GND	-			GND	-		
29	TDI	6			TDI	6		
30	TMS	6			TMS	6		
31	TDO	6			TDO	6		
32	VCCJ	6			VCCJ	6		
33	PL20A	6	T	LLM0_PLLT_IN_A	PL29A	6	T	LLM0_PLLT_IN_A
34	PL20B	6	C	LLM0_PLLC_IN_A	PL29B	6	C	LLM0_PLLC_IN_A
35	PL21A	6	T	LLM0_PLLT_FB_A	PL30A	6	T	LLM0_PLLT_FB_A
36	PL21B	6	C	LLM0_PLLC_FB_A	PL30B	6	C	LLM0_PLLC_FB_A
37	VCCIO6	6			VCCIO6	6		
38	PL22A	6	T		PL31A	6	T	
39	PL22B	6	C		PL31B	6	C	
40	PL23A	6	T		PL32A	6	T	
41	GND6	6			GND6	6		
42	PL23B	6	C		PL32B	6	C	

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
K2	PL11A	6	T	LLM0_PLLT_IN_A	PL20A	6	T	LLM0_PLLT_IN_A
K1	PL11B	6	C	LLM0_PLLC_IN_A	PL20B	6	C	LLM0_PLLC_IN_A
L2	PL12A	6	T	LLM0_PLLT_FB_A	PL21A	6	T	LLM0_PLLT_FB_A
L1	PL12B	6	C	LLM0_PLLC_FB_A	PL21B	6	C	LLM0_PLLC_FB_A
M2	PL13A	6	T		PL22A	6	T	
M1	PL13B	6	C		PL22B	6	C	
N1	PL14A	6	T		PL23A	6	T	
GND	GND6	6			GND6	6		
N2	PL14B	6	C		PL23B	6	C	
M4	PL15A	6	T	LDQS15	PL24A	6	T	LDQS24
M3	PL15B	6	C		PL24B	6	C	
P1	PL16A	6	T		PL25A	6	T	
R1	PL16B	6	C		PL25B	6	C	
P2	PL17A	6	T		PL26A	6	T	
P3	PL17B	6	C		PL26B	6	C	
N3	PL18A	6	T	VREF1_6	PL27A	6	T	VREF1_6
N4	PL18B	6	C	VREF2_6	PL27B	6	C	VREF2_6
GND	GND6	6			GND6	6		
GND	GND5	5			GND5	5		
P4	PB2A	5	T		PB2A	5	T	
N5	PB2B	5	C		PB2B	5	C	
P5	PB3A	5	T		PB3A	5	T	
P6	PB3B	5	C		PB3B	5	C	
R4	PB4A	5	T		PB4A	5	T	
R3	PB4B	5	C		PB4B	5	C	
T2	PB5A	5	T		PB5A	5	T	
T3	PB5B	5	C		PB5B	5	C	
R5	PB6A	5	T	BDQS6	PB6A	5	T	BDQS6
R6	PB6B	5	C		PB6B	5	C	
T4	PB7A	5	T		PB7A	5	T	
T5	PB7B	5	C		PB7B	5	C	
N6	PB8A	5	T		PB8A	5	T	
M6	PB8B	5	C		PB8B	5	C	
T6	PB9A	5	T		PB9A	5	T	
GND	GND5	5			GND5	5		
T7	PB9B	5	C		PB9B	5	C	
P7	PB10A	5	T		PB10A	5	T	
N7	PB10B	5	C		PB10B	5	C	
R7	PB11A	5	T		PB11A	5	T	
R8	PB11B	5	C		PB11B	5	C	
M7	PB12A	5	T		PB12A	5	T	
M8	PB12B	5	C		PB12B	5	C	
T8	PB13A	5	T		PB13A	5	T	

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND5	5			GND5	5		
T9	PB13B	5	C		PB13B	5	C	
P8	PB14A	5	T	BDQS14	PB14A	5	T	BDQS14
N8	PB14B	5	C		PB14B	5	C	
R9	PB15A	5	T		PB15A	5	T	
R10	PB15B	5	C		PB15B	5	C	
P9	PB16A	5	T	VREF2_5	PB16A	5	T	VREF2_5
N9	PB16B	5	C	VREF1_5	PB16B	5	C	VREF1_5
T10	PB17A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
GND	GND5	5			GND5	5		
T11	PB17B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
T12	PB18A	4	T	WRITEN	PB18A	4	T	WRITEN
T13	PB18B	4	C	CS1N	PB18B	4	C	CS1N
P10	PB19A	4	T	VREF1_4	PB19A	4	T	VREF1_4
N10	PB19B	4	C	CSN	PB19B	4	C	CSN
T14	PB20A	4	T	VREF2_4	PB20A	4	T	VREF2_4
T15	PB20B	4	C	D0/SPID7	PB20B	4	C	D0/SPID7
M10	PB21A	4	T	D2/SPID5	PB21A	4	T	D2/SPID5
GND	GND4	4			GND4	4		
M11	PB21B	4	C	D1/SPID6	PB21B	4	C	D1/SPID6
R11	PB22A	4	T	BDQS22	PB22A	4	T	BDQS22
P11	PB22B	4	C	D3/SPID4	PB22B	4	C	D3/SPID4
R13	PB23A	4	T		PB23A	4	T	
R14	PB23B	4	C	D4/SPID3	PB23B	4	C	D4/SPID3
P12	PB24A	4	T		PB24A	4	T	
P13	PB24B	4	C	D5/SPID2	PB24B	4	C	D5/SPID2
N11	PB25A	4	T		PB25A	4	T	
-	-	-			GND4	4		
N12	PB25B	4	C	D6/SPID1	PB25B	4	C	D6/SPID1
R12	NC	-			PB26A	4		
GND	GND4	4			GND4	4		
-	-	-			GND4	4		
GND	GND3	3			GND3	3		
N13	PR18B	3	C	VREF2_3	PR27B	3	C	VREF2_3
N14	PR18A	3	T	VREF1_3	PR27A	3	T	VREF1_3
P14	PR17B	3	C		PR26B	3	C	
P15	PR17A	3	T		PR26A	3	T	
R15	PR16B	3	C		PR25B	3	C	
R16	PR16A	3	T		PR25A	3	T	
M13	PR15B	3	C		PR24B	3	C	
M14	PR15A	3	T	RDQS15	PR24A	3	T	RDQS24
P16	PR14B	3	C	RLM0_PLLC_FB_A	PR23B	3	C	RLM0_PLLC_FB_A
GND	GND3	3			GND3	3		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
D7	PT11B	0	C		PT11B	0	C	
C7	PT11A	0	T		PT11A	0	T	
A7	PT10B	0	C		PT10B	0	C	
A6	PT10A	0	T		PT10A	0	T	
E7	PT9B	0	C		PT9B	0	C	
GND	GND0	0			GND0	0		
E6	PT9A	0	T		PT9A	0	T	
D6	PT8B	0	C		PT8B	0	C	
C6	PT8A	0	T		PT8A	0	T	
B6	PT7B	0	C		PT7B	0	C	
B5	PT7A	0	T		PT7A	0	T	
A5	PT6B	0	C		PT6B	0	C	
A4	PT6A	0	T	TDQS6	PT6A	0	T	TDQS6
A3	PT5B	0	C		PT5B	0	C	
A2	PT5A	0	T		PT5A	0	T	
B2	PT4B	0	C		PT4B	0	C	
B3	PT4A	0	T		PT4A	0	T	
D5	PT3B	0	C		PT3B	0	C	
C5	PT3A	0	T		PT3A	0	T	
C4	PT2B	0	C		PT2B	0	C	
B4	PT2A	0	T		PT2A	0	T	
GND	GND0	0			GND0	0		
A1	GND	-			GND	-		
A16	GND	-			GND	-		
G10	GND	-			GND	-		
G7	GND	-			GND	-		
G8	GND	-			GND	-		
G9	GND	-			GND	-		
H10	GND	-			GND	-		
H7	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J10	GND	-			GND	-		
J7	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K7	GND	-			GND	-		
K8	GND	-			GND	-		
K9	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
E12	VCC	-			VCC	-		

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
L3	TMS	6			TMS	6		
L5	TDO	6			TDO	6		
L4	VCCJ	6			VCCJ	6		
K2	PL29A	6	T	LLM0_PLLT_IN_A	PL37A	6	T	LLM0_PLLT_IN_A
K1	PL29B	6	C	LLM0_PLLC_IN_A	PL37B	6	C	LLM0_PLLC_IN_A
L2	PL30A	6	T	LLM0_PLLT_FB_A	PL38A	6	T	LLM0_PLLT_FB_A
L1	PL30B	6	C	LLM0_PLLC_FB_A	PL38B	6	C	LLM0_PLLC_FB_A
M2	PL31A	6	T		PL39A	6	T	
M1	PL31B	6	C		PL39B	6	C	
N1	PL32A	6	T		PL40A	6	T	
GND	GND6	6			GND6	6		
-	-	-			GND6	6		
N2	PL32B	6	C		PL40B	6	C	
M4	PL33A	6	T	LDQS33	PL41A	6	T	LDQS41
M3	PL33B	6	C		PL41B	6	C	
P1	PL34A	6	T		PL42A	6	T	
R1	PL34B	6	C		PL42B	6	C	
P2	PL35A	6	T		PL43A	6	T	
P3	PL35B	6	C		PL43B	6	C	
N3	PL36A	6	T	VREF1_6	PL44A	6	T	VREF1_6
N4	PL36B	6	C	VREF2_6	PL44B	6	C	VREF2_6
GND	GND6	6			GND6	6		
GND	GND5	5			GND5	5		
GND	GND5	5			GND5	5		
P4	PB10A	5	T		PB10A	5	T	
N5	PB10B	5	C		PB10B	5	C	
P5	PB11A	5	T		PB11A	5	T	
P6	PB11B	5	C		PB11B	5	C	
R4	PB12A	5	T		PB12A	5	T	
R3	PB12B	5	C		PB12B	5	C	
T2	PB13A	5	T		PB13A	5	T	
GND	GND5	5			GND5	5		
T3	PB13B	5	C		PB13B	5	C	
R5	PB14A	5	T	BDQS14	PB14A	5	T	BDQS14
R6	PB14B	5	C		PB14B	5	C	
T4	PB15A	5	T		PB15A	5	T	
T5	PB15B	5	C		PB15B	5	C	
N6	PB16A	5	T		PB16A	5	T	
M6	PB16B	5	C		PB16B	5	C	
T6	PB17A	5	T		PB17A	5	T	
GND	GND5	5			GND5	5		
T7	PB17B	5	C		PB17B	5	C	
P7	PB18A	5	T		PB18A	5	T	

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
N22	PR30A	3	T		N22	PR42A	3	T	
N19	PR29B	3	C		N19	PR41B	3	C	
N18	PR29A	3	T		N18	PR41A	3	T	
M21	PR28B	3	C		M21	PR40B	3	C	
L20	PR28A	3	T	RDQS28	L20	PR40A	3	T	RDQS40
L21	PR27B	3	C		L21	PR39B	3	C	
GND	GND3	3			GND	GND3	3		
M20	PR27A	3	T		M20	PR39A	3	T	
M18	PR26B	3	C		M18	PR38B	3	C	
M19	PR26A	3	T		M19	PR38A	3	T	
M22	PR25B	3	C		M22	PR37B	3	C	
L22	PR25A	3	T		L22	PR37A	3	T	
K22	PR24B	3	C		K22	PR36B	3	C	
K21	PR24A	3	T		K21	PR36A	3	T	
J22	PR22B	2	C	PCLKC2_0	J22	PR34B	2	C	PCLKC2_0
GND	GND2	2			GND	GND2	2		
J21	PR22A	2	T	PCLKT2_0	J21	PR34A	2	T	PCLKT2_0
H22	PR21B	2	C		H22	PR33B	2	C	
H21	PR21A	2	T		H21	PR33A	2	T	
L19	PR20B	2	C		L19	PR32B	2	C	
L18	PR20A	2	T		L18	PR32A	2	T	
K20	PR19B	2	C		K20	PR31B	2	C	
J20	PR19A	2	T	RDQS19	J20	PR31A	2	T	RDQS31
K19	PR18B	2	C		K19	PR30B	2	C	
GND	GND2	2			GND	GND2	2		
K18	PR18A	2	T		K18	PR30A	2	T	
G22	PR17B	2	C		G22	PR29B	2	C	
F22	PR17A	2	T		F22	PR29A	2	T	
F21	PR16B	2	C		F21	PR28B	2	C	
E22	PR16A	2	T		E22	PR28A	2	T	
E21	PR15B	2	C		E21	PR27B	2	C	
D22	PR15A	2	T		D22	PR27A	2	T	
G21	PR14B	2	C		G21	PR26B	2	C	
G20	PR14A	2	T		G20	PR26A	2	T	
GND	GND2	2			GND	GND2	2		
J18	PR13B	2	C		J18	PR25B	2	C	
H19	PR13A	2	T		H19	PR25A	2	T	
J19	PR12B	2	C		J19	PR24B	2	C	
H20	PR12A	2	T		H20	PR24A	2	T	
H17	PR11B	2	C		H17	PR23B	2	C	
H18	PR11A	2	T		H18	PR23A	2	T	RDQS23
D21	PR9B	2	C	RUM0_PLLC_FB_A	D21	PR17B	2	C	RUM0_PLLC_FB_A
GND	GND2	2			GND	GND2	2		
GND	-	-			GND	GND2	2		

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
L7	VCCIO7	7			L7	VCCIO7	7		
L8	VCCIO7	7			L8	VCCIO7	7		
G15	VCCAUX	-			G15	VCCAUX	-		
G16	VCCAUX	-			G16	VCCAUX	-		
G7	VCCAUX	-			G7	VCCAUX	-		
G8	VCCAUX	-			G8	VCCAUX	-		
H16	VCCAUX	-			H16	VCCAUX	-		
H7	VCCAUX	-			H7	VCCAUX	-		
R16	VCCAUX	-			R16	VCCAUX	-		
R7	VCCAUX	-			R7	VCCAUX	-		
T15	VCCAUX	-			T15	VCCAUX	-		
T16	VCCAUX	-			T16	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-		
J6	VCC ¹	-			J6	VCCPLL	-		
J17	VCC ¹	-			J17	VCCPLL	-		
P6	VCC ¹	-			P6	VCCPLL	-		
P17	VCC ¹	-			P17	VCCPLL	-		
A2	NC	-			A2	NC	-		
AB2	NC	-			AB2	NC	-		
A21	NC	-			A21	NC	-		

 1. Tied to V_{CCPLL}.

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
Y6	NC	-			Y6	PL62A	6	T	
W7	NC	-			W7	PL62B	6	C	
AA4	NC	-			AA4	PL63A	6	T	
AB3	NC	-			AB3	PL63B	6	C	
AC2	NC	-			AC2	PL64A	6	T	
-	-	-			GND	GND6	6		
AC3	NC	-			AC3	PL64B	6	C	
AA5	NC	-			AA5	PL65A	6	T	LDQS65
AB5	NC	-			AB5	PL65B	6	C	
AD3	NC	-			AD3	PL66A	6	T	
AD2	NC	-			AD2	PL66B	6	C	
AE1	NC	-			AE1	PL67A	6	T	
AD1	NC	-			AD1	PL67B	6	C	
AB4	PL48A	6	T	VREF1_6	AB4	PL68A	6	T	VREF1_6
AC4	PL48B	6	C	VREF2_6	AC4	PL68B	6	C	VREF2_6
GND	GND6	6			GND	GND6	6		
GND	GND5	5			GND	GND5	5		
AB6	PB2A	5	T		AB6	PB2A	5	T	
AA6	PB2B	5	C		AA6	PB2B	5	C	
AC7	PB3A	5	T		AC7	PB3A	5	T	
Y8	PB3B	5	C		Y8	PB3B	5	C	
AB7	PB4A	5	T		AB7	PB4A	5	T	
AA7	PB4B	5	C		AA7	PB4B	5	C	
AC6	PB5A	5	T		AC6	PB5A	5	T	
AC5	PB5B	5	C		AC5	PB5B	5	C	
AB8	PB6A	5	T	BDQS6	AB8	PB6A	5	T	BDQS6
AC8	PB6B	5	C		AC8	PB6B	5	C	
AE2	PB7A	5	T		AE2	PB7A	5	T	
AA8	PB7B	5	C		AA8	PB7B	5	C	
AF2	PB8A	5	T		AF2	PB8A	5	T	
Y9	PB8B	5	C		Y9	PB8B	5	C	
AD5	PB9A	5	T		AD5	PB9A	5	T	
GND	GND5	5			GND	GND5	5		
AD4	PB9B	5	C		AD4	PB9B	5	C	
AD8	PB10A	5	T		AD8	PB10A	5	T	
AC9	PB10B	5	C		AC9	PB10B	5	C	
AE3	PB11A	5	T		AE3	PB11A	5	T	
AB9	PB11B	5	C		AB9	PB11B	5	C	
AF3	PB12A	5	T		AF3	PB12A	5	T	
AD9	PB12B	5	C		AD9	PB12B	5	C	
AE4	PB13A	5	T		AE4	PB13A	5	T	
GND	GND5	5			GND	GND5	5		

Conventional Packaging
LatticeEC Commercial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC1E-3Q208C	112	-3	PQFP	208	COM	1.5K
LFEC1E-4Q208C	112	-4	PQFP	208	COM	1.5K
LFEC1E-5Q208C	112	-5	PQFP	208	COM	1.5K
LFEC1E-3T144C	97	-3	TQFP	144	COM	1.5K
LFEC1E-4T144C	97	-4	TQFP	144	COM	1.5K
LFEC1E-5T144C	97	-5	TQFP	144	COM	1.5K
LFEC1E-3T100C	67	-3	TQFP	100	COM	1.5K
LFEC1E-4T100C	67	-4	TQFP	100	COM	1.5K
LFEC1E-5T100C	67	-5	TQFP	100	COM	1.5K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC3E-3F256C	160	-3	fpBGA	256	COM	3.1K
LFEC3E-4F256C	160	-4	fpBGA	256	COM	3.1K
LFEC3E-5F256C	160	-5	fpBGA	256	COM	3.1K
LFEC3E-3Q208C	145	-3	PQFP	208	COM	3.1K
LFEC3E-4Q208C	145	-4	PQFP	208	COM	3.1K
LFEC3E-5Q208C	145	-5	PQFP	208	COM	3.1K
LFEC3E-3T144C	97	-3	TQFP	144	COM	3.1K
LFEC3E-4T144C	97	-4	TQFP	144	COM	3.1K
LFEC3E-5T144C	97	-5	TQFP	144	COM	3.1K
LFEC3E-3T100C	67	-3	TQFP	100	COM	3.1K
LFEC3E-4T100C	67	-4	TQFP	100	COM	3.1K
LFEC3E-5T100C	67	-5	TQFP	100	COM	3.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC6E-3F484C	224	-3	fpBGA	484	COM	6.1K
LFEC6E-4F484C	224	-4	fpBGA	484	COM	6.1K
LFEC6E-5F484C	224	-5	fpBGA	484	COM	6.1K
LFEC6E-3F256C	195	-3	fpBGA	256	COM	6.1K
LFEC6E-4F256C	195	-4	fpBGA	256	COM	6.1K
LFEC6E-5F256C	195	-5	fpBGA	256	COM	6.1K
LFEC6E-3Q208C	147	-3	PQFP	208	COM	6.1K
LFEC6E-4Q208C	147	-4	PQFP	208	COM	6.1K
LFEC6E-5Q208C	147	-5	PQFP	208	COM	6.1K
LFEC6E-3T144C	97	-3	TQFP	144	COM	6.1K
LFEC6E-4T144C	97	-4	TQFP	144	COM	6.1K
LFEC6E-5T144C	97	-5	TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-3F484C	288	-3	fpBGA	484	COM	10.2K
LFEC10E-4F484C	288	-4	fpBGA	484	COM	10.2K
LFEC10E-5F484C	288	-5	fpBGA	484	COM	10.2K
LFEC10E-3F256C	195	-3	fpBGA	256	COM	10.2K

LatticeEC Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC10E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	10.2K
LFEC10E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	10.2K
LFEC10E-3QN208C	147	-3	Lead-Free PQFP	208	COM	10.2K
LFEC10E-4QN208C	147	-4	Lead-Free PQFP	208	COM	10.2K
LFEC10E-5QN208C	147	-5	Lead-Free PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC15E-3FN484C	352	-3	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-4FN484C	352	-4	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-5FN484C	352	-5	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	15.3K
LFEC15E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	15.3K
LFEC15E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC20E-3FN672C	400	-3	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-4FN672C	400	-4	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-5FN672C	400	-5	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	19.7K
LFEC20E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	19.7K
LFEC20E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC33E-3FN672C	496	-3	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-4FN672C	496	-4	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-5FN672C	496	-5	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	32.8K

LatticeECP Commercial

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP6E-3FN484C	224	-3	Lead-Free fpBGA	484	COM	6.1K
LFCEP6E-4FN484C	224	-4	Lead-Free fpBGA	484	COM	6.1K
LFCEP6E-5FN484C	224	-5	Lead-Free fpBGA	484	COM	6.1K
LFCEP6E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	6.1K
LFCEP6E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	6.1K
LFCEP6E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	6.1K
LFCEP6E-3QN208C	147	-3	Lead-Free PQFP	208	COM	6.1K
LFCEP6E-4QN208C	147	-4	Lead-Free PQFP	208	COM	6.1K
LFCEP6E-5QN208C	147	-5	Lead-Free PQFP	208	COM	6.1K
LFCEP6E-3TN144C	97	-3	Lead-Free TQFP	144	COM	6.1K
LFCEP6E-4TN144C	97	-4	Lead-Free TQFP	144	COM	6.1K
LFCEP6E-5TN144C	97	-5	Lead-Free TQFP	144	COM	6.1K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP10E-3FN484C	288	-3	Lead-Free fpBGA	484	COM	10.2K
LFCEP10E-4FN484C	288	-4	Lead-Free fpBGA	484	COM	10.2K
LFCEP10E-5FN484C	288	-5	Lead-Free fpBGA	484	COM	10.2K
LFCEP10E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	10.2K
LFCEP10E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	10.2K
LFCEP10E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	10.2K
LFCEP10E-3QN208C	147	-3	Lead-Free PQFP	208	COM	10.2K
LFCEP10E-4QN208C	147	-4	Lead-Free PQFP	208	COM	10.2K
LFCEP10E-5QN208C	147	-5	Lead-Free PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP15E-3FN484C	352	-3	Lead-Free fpBGA	484	COM	15.3K
LFCEP15E-4FN484C	352	-4	Lead-Free fpBGA	484	COM	15.3K
LFCEP15E-5FN484C	352	-5	Lead-Free fpBGA	484	COM	15.3K
LFCEP15E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	15.3K
LFCEP15E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	15.3K
LFCEP15E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP20E-3FN672C	400	-3	Lead-Free fpBGA	672	COM	19.7K
LFCEP20E-4FN672C	400	-4	Lead-Free fpBGA	672	COM	19.7K
LFCEP20E-5FN672C	400	-5	Lead-Free fpBGA	672	COM	19.7K
LFCEP20E-3FN484C	400	-3	Lead-Free fpBGA	484	COM	19.7K
LFCEP20E-4FN484C	400	-4	Lead-Free fpBGA	484	COM	19.7K
LFCEP20E-5FN484C	400	-5	Lead-Free fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP33E-3FN672C	496	-3	Lead-Free fpBGA	672	COM	32.8K
LFCEP33E-4FN672C	496	-4	Lead-Free fpBGA	672	COM	32.8K
LFCEP33E-5FN672C	496	-5	Lead-Free fpBGA	672	COM	32.8K

Date	Version	Section	Change Summary
December 2004	01.4	Architecture	Updated Hot Socketing Recommended Power Up Sequence section.
		Pinout Information	Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Pin Information
			Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Power Supply and NC Connections
			Added LFEC1 and LFEC3 100 TQFP Pinout
			Added LFEC1 and LFEC3 144 TQFP Pinout
			Added LFEC1, LFEC3 and LFECP/EC10 208 PQFP Pinout
			Added LFEC3, LFECP/EC10 and LFECP/EC15 256 fpBGA Pinout
			Added LFECP/EC10 and LFECP/EC15 484 fpBGA Pinout
		Ordering Information	Added Lead-Free Package Designators
			Added Lead-Free Ordering Part Numbers
		Supplemental Information	Updated list of technical notes.
April 2005	01.5	Architecture	EBR memory support section has been updated with clarification.
			Updated sysIO buffer pair section.
		DC & Switching Characteristics	Hot Socketing Specification has been updated.
			DC Electrical Characteristics table (I_{IL} , I_{IH}) has been updated.
			Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			External Switching Characteristics section has been updated.
			Removed t_{RSTW} spec. from PLL Parameter table.
			t_{RST} specifications have been updated.
			sysCONFIG Port Timing Specifications (t_{BSCL} , t_{ODISS} , t_{PRGMRJ}) have been updated.
		Pinout Information	Added LFECP/EC33 Pinout Information
			Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
			484-fpBGA logic connection has been updated (Ball # J6, J17, P6 and P17 for ECP/EC33 are now called VCCPLL).
			672-fpBGA logic connection has been updated (Ball # K19, L8, U19, U8 for ECP/EC33 are now called VCCPLL).
May 2005	01.6	Introduction	ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.
		Architecture	Table 2-10 has been updated (ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.)
			Recommended Power Up Sequence section has been removed.
		DC & Switching Characteristics	Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			Vos test condition has been updated to $(VOP+VOM)/2$.
			Register-to-Register performance table has been updated (rev. G 0.27).
			External switching characteristics have been updated (rev. G 0.27).
			Internal timing parameters have been updated (rev. G 0.27).
			Timing adders have been updated (rev. G 0.27).
			sysCONFIG port timing specifications have been updated.
		Pinout Information	Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
		Ordering Information	OPN list has been updated.